

Display Elektronik GmbH

DATA SHEET

TFT MODULE

**DEM 3202400 VMH-PW-N
(A-TOUCH)**

3,5" TFT + Touch

Product Specification

Ver.: 1

04.06.2015

Revision History

Revision	Date	Detail	Remarks
0	17.04.2015	Initial Release	-
1	04.06.2015	Modify Chromacity Transmissive Modify Outline Drawing	P8 P31

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver Ics, a touch panel and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size (Diagonal)	3.5"	-
LCD Type	MVA TFT	-
Display Mode	Transmissive / Normally White	-
Resolution	320 x RGB x 240	Pixels
View Direction	FULL VIEW	Best Image
Module Outline	76.90 x 63.90 x 4.40 (Note1)	mm
Active Area	70.08 x 52.56	mm
Pixel Size	0.219 x 0.219	mm
Pixel Arrangement	RGB stripe	-
Polarizer Surface Treatment	Anti-Glare	-
Display Colors	16.7 Million	-
Interface	24-Bit-RGB-Interface + 3-Wire-SPI	-
Driver IC	HX8238D (Himax)	-
With or Without Touch Panel	With Touch	-
Operating Temperature	-20°C to +70°C	°C
Storage Temperature	-30°C to +80°C	°C
Weight	42	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum RatingsV_{SS}=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	V _{DD}	-0.3	5.0	V
Storage Temperature	T _{stg}	-30	+80	°C
Operating Temperature	T _{op}	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	
Supply Voltage	V _{DD}	3.0	3.3	3.6	V	
Logic Low Input Voltage	V _{IL}	GND	-	0.2*V _{DD}	V	
Logic High Input Voltage	V _{IH}	0.8*V _{DD}	-	V _{DD}	V	
Logic Low Output Voltage	V _{OL}	GND	-	0.1*V _{DD}	V	
Logic High Output Voltage	V _{OH}	0.9*V _{DD}	-	V _{DD}	V	
Current Consumption All Black	Logic	-	-	20	30	mA
	Analog					

5. Backlight Characteristic

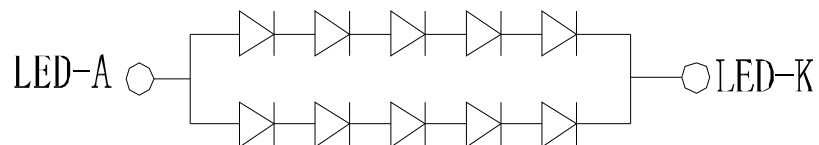
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	T _a =25°C, I _F =20mA/LED	14.5	16	16.5	V
Forward Current	I _F	T _a =25°C, V _F =3.2V/LED	-	40	-	mA
Power Dissipation	P _d		-	640	-	mW
Uniformity	Avg		80	85	-	%
LED Lifetime (25°C)	-		-	30,000	-	Hrs
Drive Method	Constant current					
LED Configuration	10 White LEDs (5 LEDs in string and 2 groups in parallel)					

Note: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at T_a=25±2 °C, 60%RH±5%, I_F=20mA.

5.2. Backlighting Circuit



6. Touch Screen Panel Specifications**6.1 Electrical Characteristics**

Item	Min.	Typ.	Max.	Unit	Note
Linearity	-1.5	-	1.5	%	Analog X and Y directions
Terminal Resistance	300	-	850	Ω	X (Film side)
	150	-	550	Ω	Y (Glass side)
Insulation Resistance	20	-	-	M Ω	DC \leq 10V
Voltage	-	-	10	V	DC
Chattering	-	-	10	ms	

Caution (1): Do not operate it with a thing except a polyacetal pen (tip R0.8mm or less) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

6.2 Mechanical & Reliability Characteristics

Item	Min.	Typ.	Max.	Unit	Note
Activation force	-	-	100	g	(1)
Durability-surface scratching	Write 20,000	-	-	characters	(2)
Durability-surface pitting	1,000,000	-	-	touches	(3)
Surface hardness	3	-	-	H	

Note (1) Stylus pen Input: R0.8mm polyacetal pen or Finger

Note (2) Measurement for Surface area

- Force: 150-250gf
- Speed: 60mm/sec
- Stylus: R0.8 polyacetal pen or Finger

Note (3) Pit 1,000,000 times on the Film with a R3.75 silicon rubber.

- Force: Force: 2.45N
- Speed: 3times/sec

7. Optical Characteristics

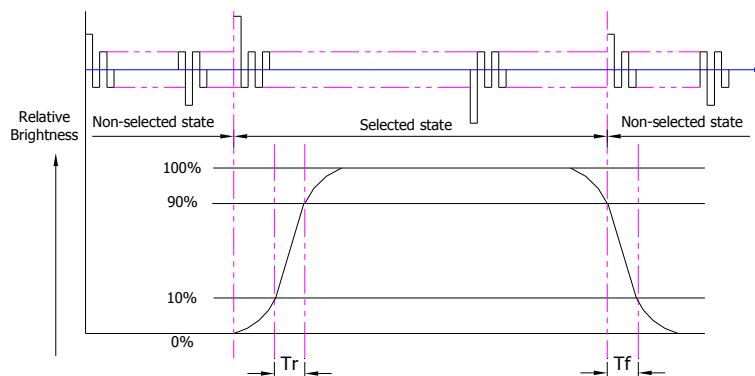
7.1. Optical Characteristics

Ta=25°C, V_{DD}=3.3V, TN LC+ Polarizer

	Item	Symbol	Condition	Specification			Unit	
				Min.	Typ.	Max.		
Backlight On (Transmissive Mode)	Luminance on TFT(I _f =20mA/LED)	Lv	Normally viewing angle θ _x = φ _y = 0°	265	330	-	cd/m ²	
	Contrast Ratio(See 7.3)	CR		300	350	-		
	Response Time (See 7.2)	T _R +T _F		-	25	40	ms	
	Chromaticity Transmissive (See 7.5)	Red	X _R	Center CR≥10	0.530	0.580	0.630	
			Y _R		0.284	0.334	0.384	
		Green	X _G		0.258	0.308	0.358	
			Y _G		0.568	0.618	0.668	
		Blue	X _B		0.092	0.142	0.192	
			Y _B		0.053	0.103	0.153	
	White	X _W	0.227	0.277	0.327			
Y _W		0.293	0.343	0.393				
Viewing Angle (See 7.4)	Horizontal	θ _{x+}	Center CR≥10	60	75	-	Deg.	
		θ _{x-}		60	75	-		
	Vertical	φ _{y+}		60	75	-		
		φ _{y-}		60	75	-		
NTSC Ratio(Gamut)				-	53	-	%	

7.2. Definition of Response Time

7.2.1. Normally Black Type (Negative)

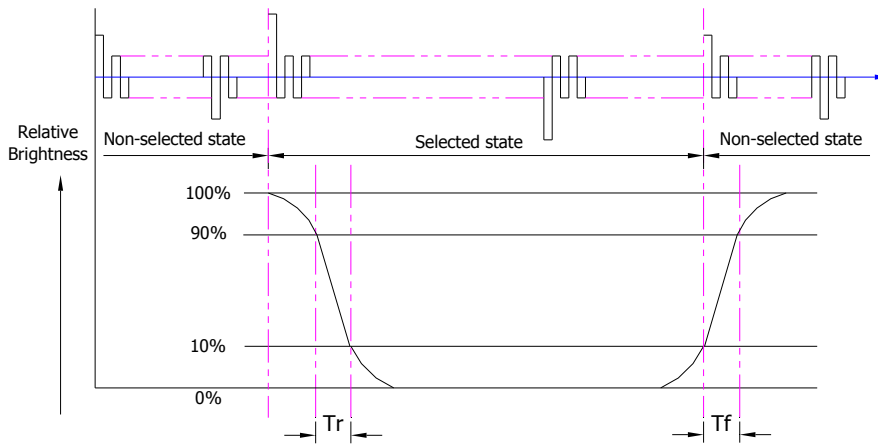


Tr is the time it takes to change from non-selected state with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note : Measuring machine: LCD-5100

7.2.2. Normally White Type (Positive)



T_r is the time it takes to change from non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

T_f is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note : Measuring machine: LCD-5100 or EQUI

7.3. Definition of Contrast Ratio

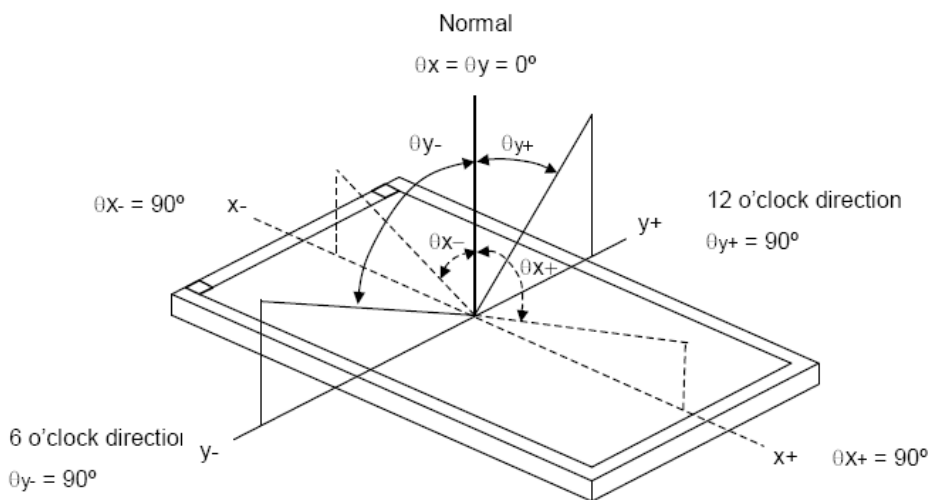
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

7.4. Definition of Viewing Angles



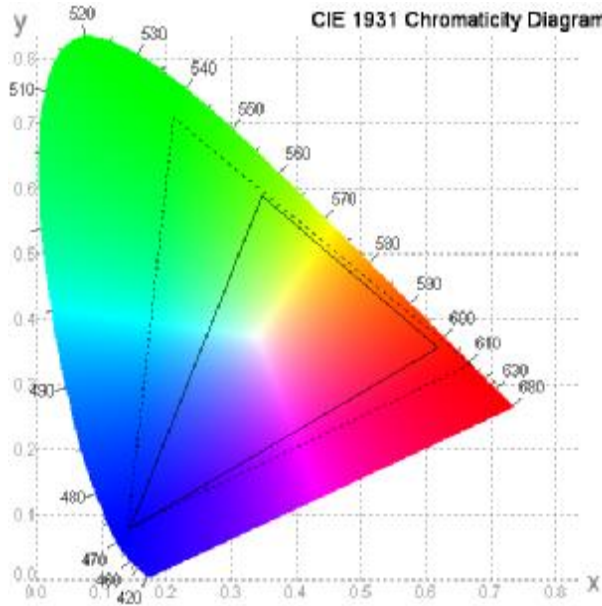
Measuring machine: LCD-5100 or EQUI

7.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



7.6. Definition of Surface Luminance, Uniformity and Transmittance

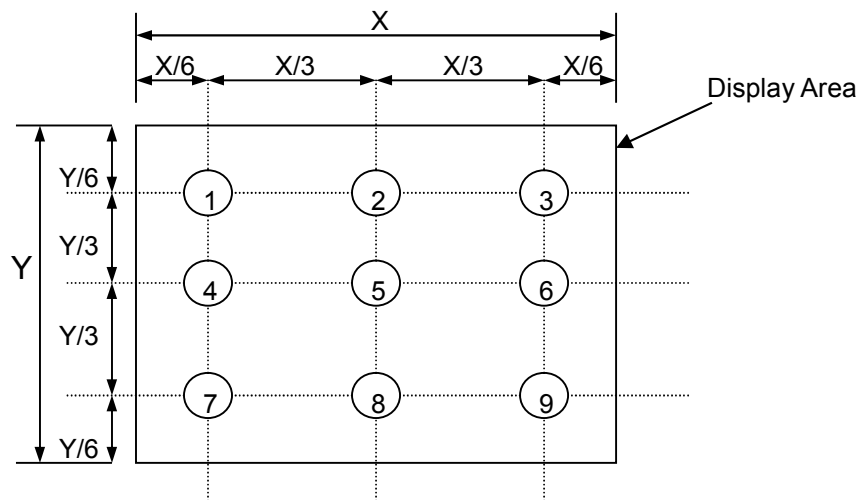
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

7.6.1. Surface Luminance: $L_v = \text{average} (L_{P1}:L_{P9})$

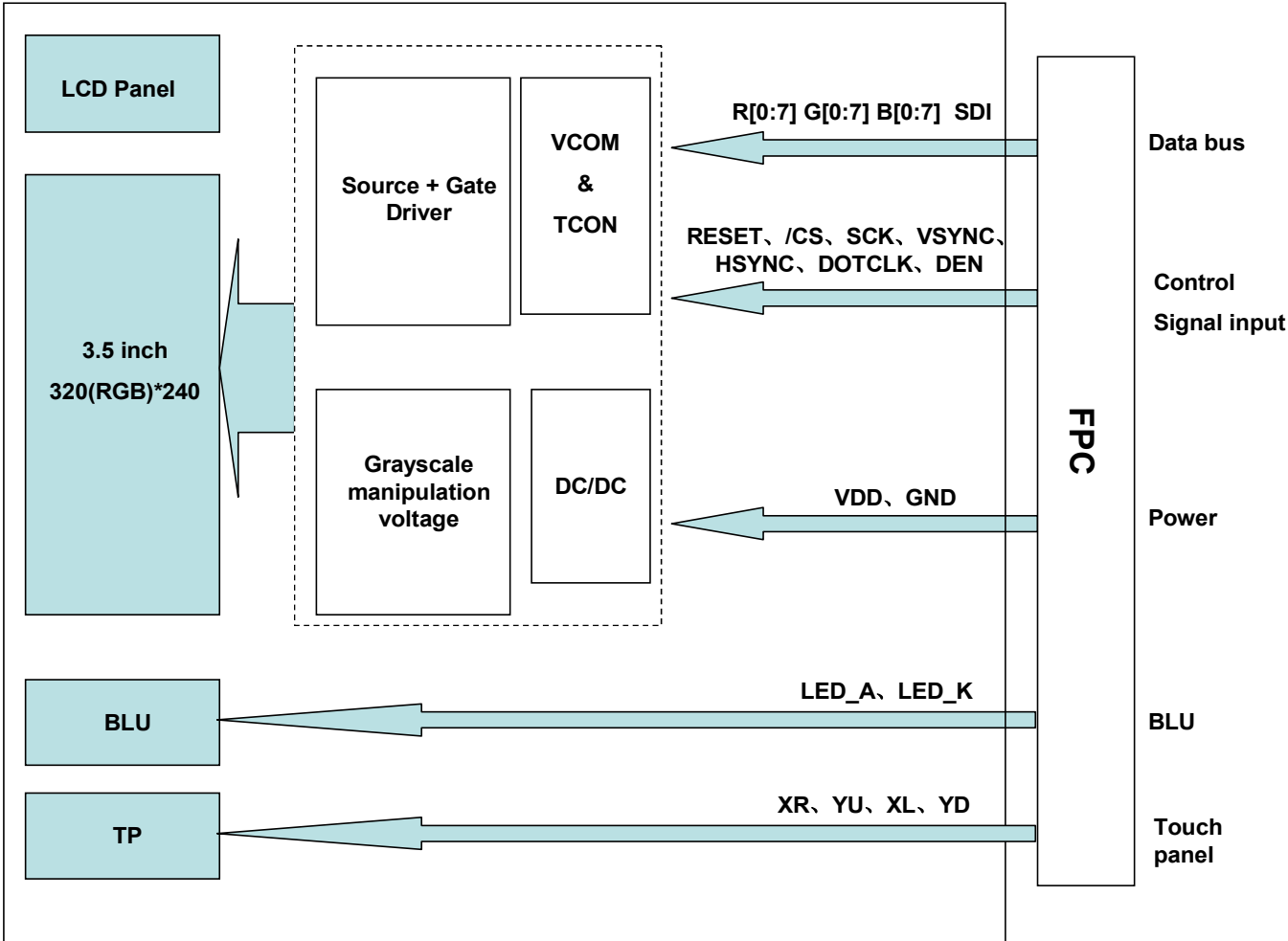
7.6.2. Uniformity = $\text{Minimal} (L_{P1}:L_{P9}) / \text{Maximal} (L_{P1}:L_{P9}) * 100\%$

7.6.3. Transmittance = $L_v \text{ on LCD} / L_v \text{ on Backlight} * 100\%$

Note: Measuring machine: BM-7



8. Block Diagram and Power Supply



9. Interface Pins Definition

No.	Symbol	Function	Remark
1-2	LED_ K	LED cathode.	
3-4	LED_ A	LED anode.	
5-7	NC	No connect.	
8	RESET	Reset signal, Low active.	
9	/CS	Chip select.	
10	SCK	SPI Serial Clock.	
11	SDI	SPI Serial Data Input/output.	
12-19	B0-B7	Data bus.	
20-27	G0-G7	Data bus.	
28-35	R0-R7	Data bus.	
36	HSYNC	Horizontal Synchronous Signal.	
37	VSYNC	Vertical Synchronous Signal.	
38	DOTCLK	Data Clock.	
39-40	NC	No connect.	
41-42	VDD	Power Supply.	
43-47	NC	No connect.	
48	XR	Touch panel terminal.	
49	YD	Touch panel terminal.	
50	XL	Touch panel terminal.	
51	YU	Touch panel terminal.	
52	DEN	Data enabling signal.	
53-54	GND	Ground.	

10. AC Characteristics

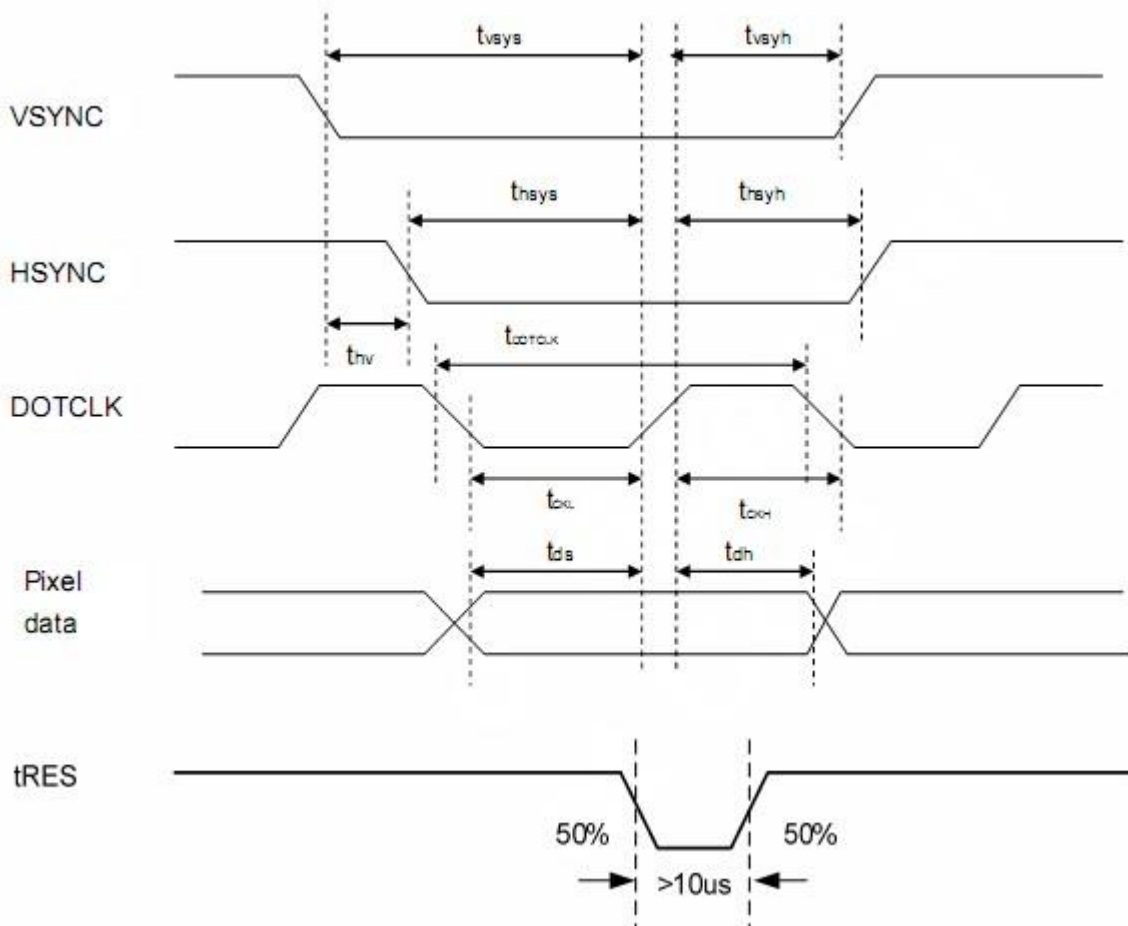
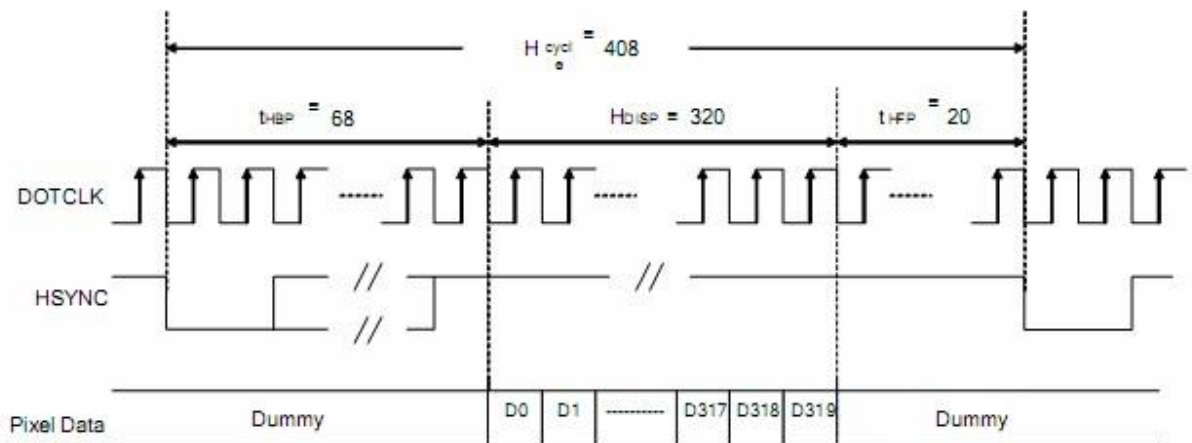


Figure 1: Pixel Timing

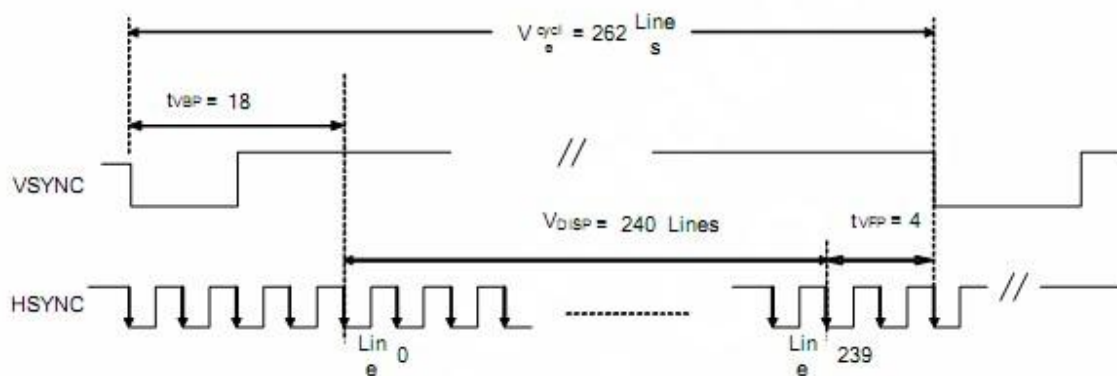
Characteristics	Symbol	Min.		Typ.		Max.		Unit
		24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	
DOTCLK Frequency	fDOTCLK	-	-	6.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3	-	-	ns
Vertical Sync Setup Time	tvsys	20	10	-	-	-	-	ns
Vertical Sync Hold Time	tshyh	20	10	-	-	-	-	ns
Horizontal Sync Setup Time	tshys	20	10	-	-	-	-	ns
Horizontal Sync Hold Time	tshyh	20	10	-	-	-	-	ns
Phase difference of Sync Signal Falling Edge	thv	1		-		240		tDOTCLK
DOTCLK Low Period	tCKL	50	15	-	-	-	-	ns
DOTCLK High Period	tCKH	50	15	-	-	-	-	ns
Data Setup Time	tds	12	10	-	-	-	-	ns
Data hold Time	tdh	12	10	-	-	-	-	ns
Reset pulse width	tRES	10		-		-		µs

Note: External clock source must be provided to DOTCLK pin of HX8238-D. The driver will not operate if absent of the docking signal.

Table 1: Pixel Timing



(a) Horizontal Data Transaction Timing



(b) Vertical Data Transaction Timing

Figure 2: Data Transaction Timing in Parallel RGB(24 bit) Interface(SYNC Mode)

Characteristics	Symbol	Min.		Typ.		Max.		Unit
		24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	
DOTCLK Frequency	f _{DOTCLK}	-	-	6.5	19.5	10	30	MHz
DOTCLK Period	t _{DOTCLK}	100	33.3	154	51.3	-	-	ns
Horizontal Frequency (Line)	f _H	-	-	14.9		22.35		KHz
Vertical Frequency (Refresh)	f _V	-	-	60		90		Hz
Horizontal Back Porch	t _{HBP}	-	-	68	204	-	-	t _{DOTCLK}
Horizontal Front Porch	t _{HFP}	-	-	20	60	-	-	t _{DOTCLK}
Horizontal Data Start Point	t _{HBP}	-	-	68	204	-	-	t _{DOTCLK}
Horizontal Blanking Period	t _{HBP} + t _{HFP}	-	-	88	264	-	-	t _{DOTCLK}
Horizontal Display Area	H _{DISP}	-	-	320	960	-	-	t _{DOTCLK}
Horizontal Cycle	H _{cycle}	-	-	408	1224	450	1350	t _{DOTCLK}
Vertical Back Porch	t _{VBP}	-	-	18		-		Lines
Vertical Front Porch	t _{VFP}	-	-	4		-		Lines
Vertical Data Start Point	t _{VBP}	-	-	18		-		Lines
Vertical Blanking Period	t _{VBP} + t _{VFP}	-	-	22		-		Lines
Vertical Display Area	NTSC	-	-	240		-	-	Lines
	PAL			280(PALM=0)				
	PAL			288(PALM=1)				
Vertical Cycle	NTSC	-	-	262		350	-	Lines
	PAL			313				

Table 2: Data Transaction Timing in Normal Operating Mode

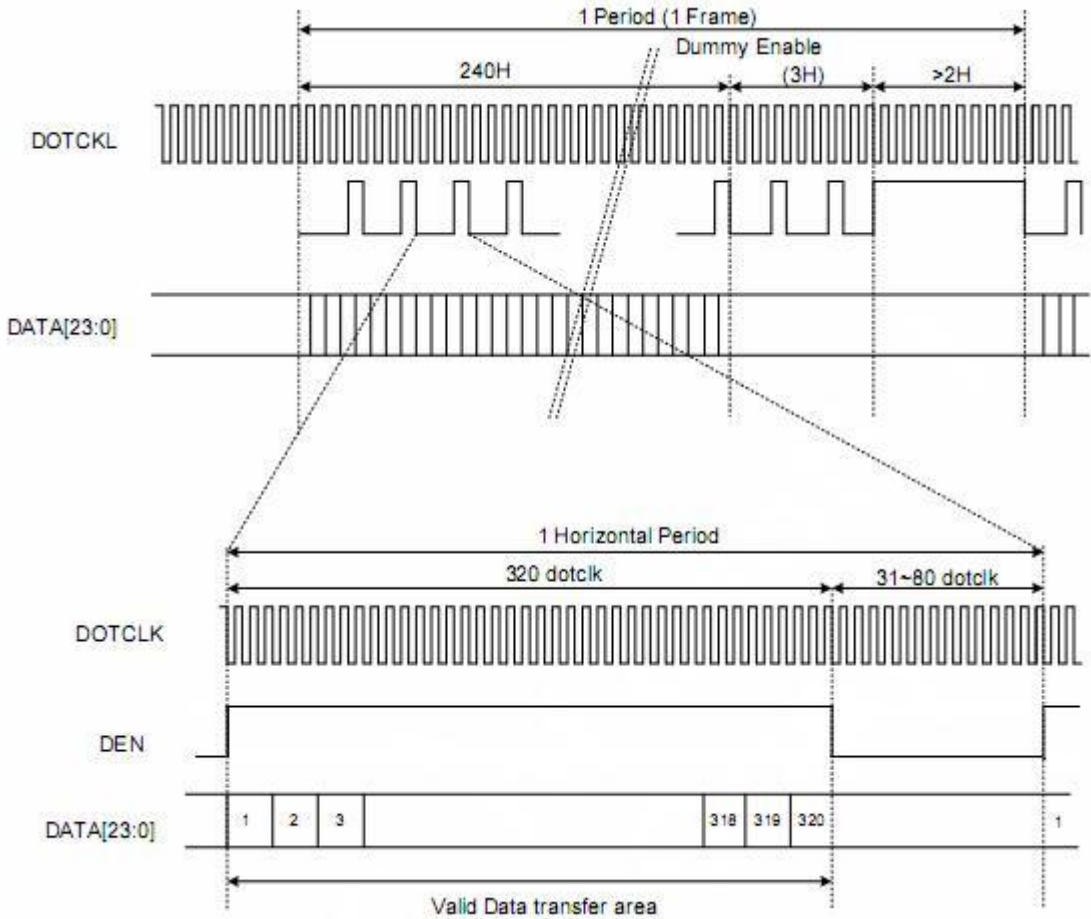


Figure 3: Signal Timing in DE Mode

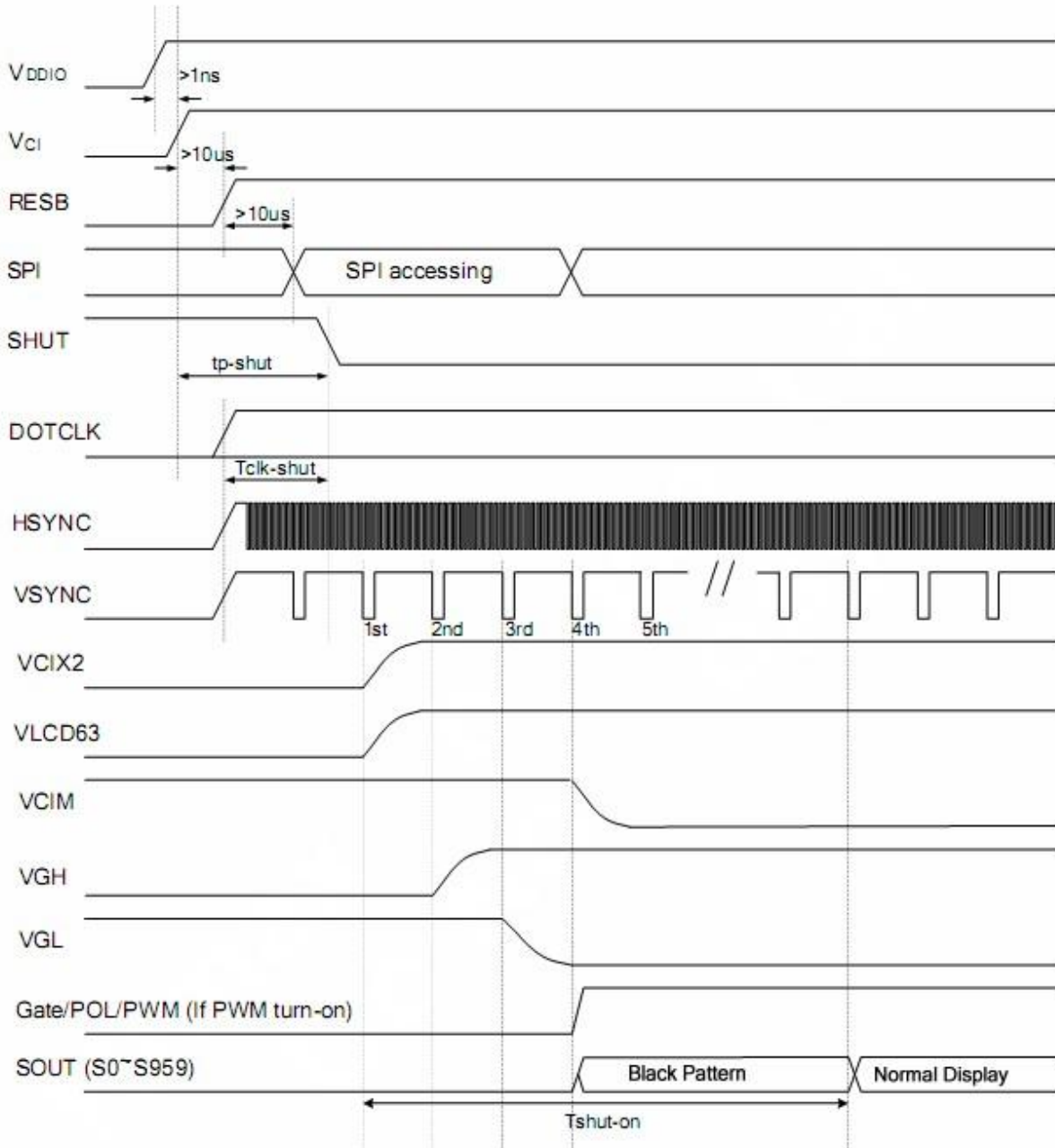


Figure 4: Power Up Sequence

Characteristics	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
VDDD / VDDIO on to falling edge of SHUT	tp-shut	1	-	-	μs
DOTCLK	tclk-shut	1	-	-	clk
Falling edge of SHUT to display start - 1 line: 408 clk - 1 frame: 262 line - DOTCLK = 6.5MHz	tshut-on	-	-	14	frame
		-	166	232.4	ms

Note: It is necessary to input DOTCLK before the falling edge of SHUT.
Display starts at 10th falling edge of VSTNC after the falling edge of SHUT.

Table 3: Power Up Sequence

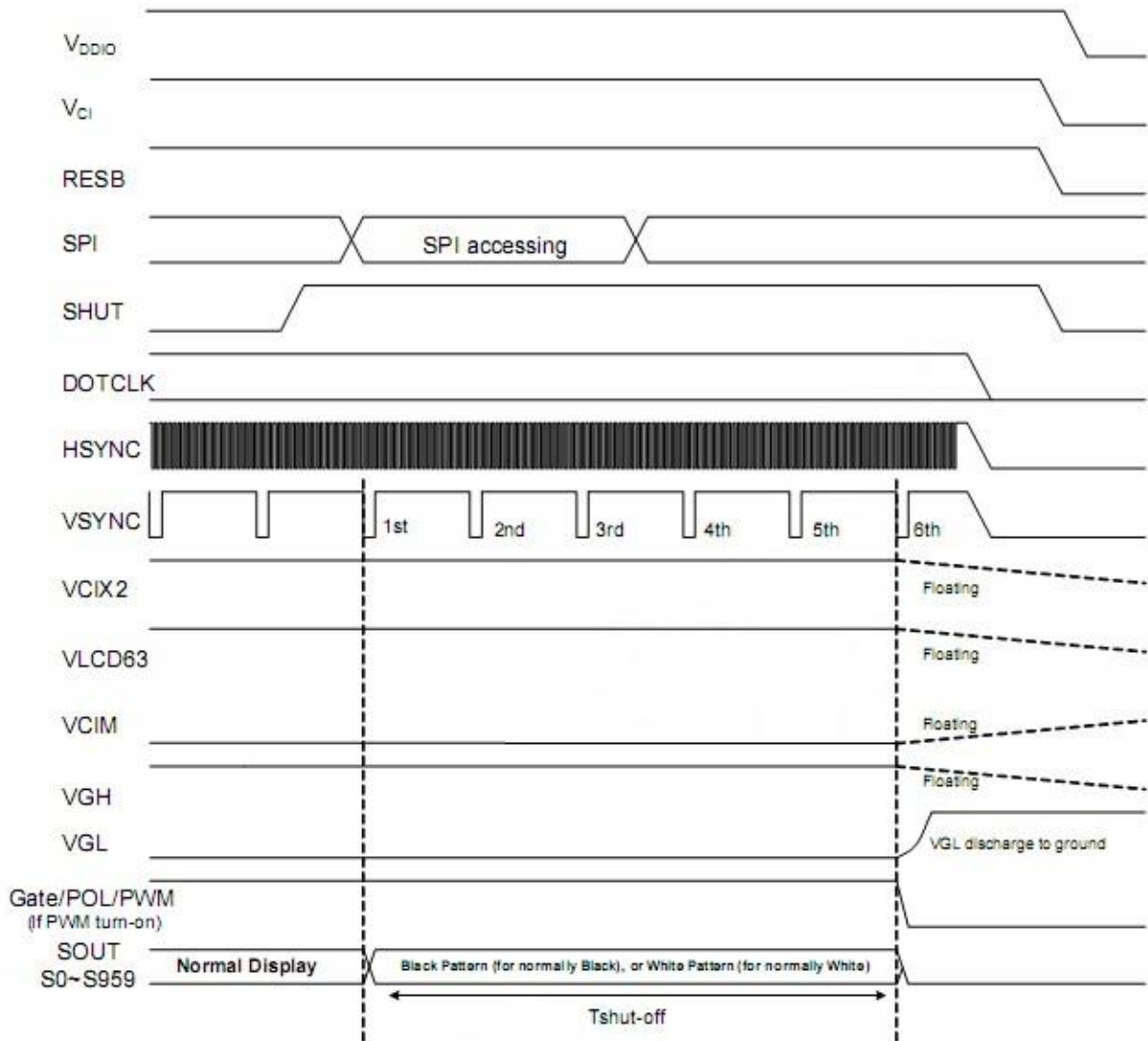


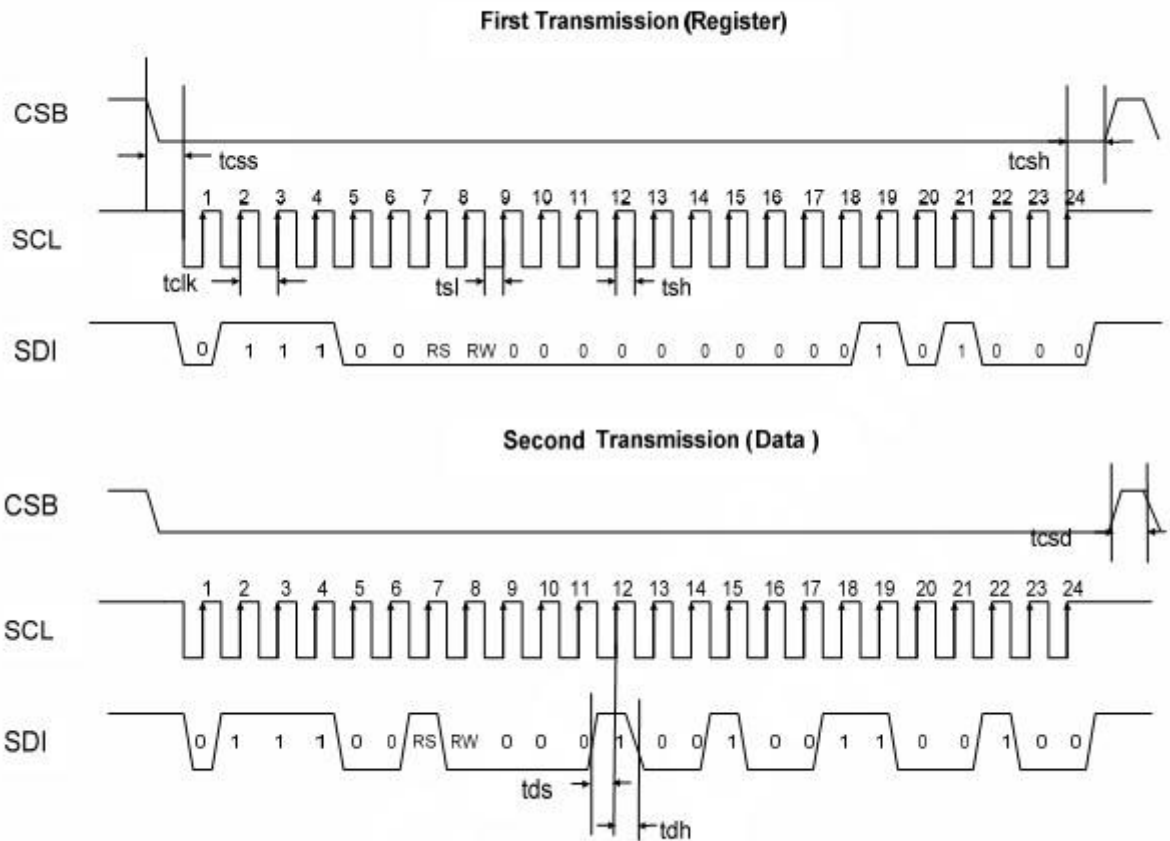
Figure 5: Power Down Sequence

Characteristics	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
Rising edge of SHUT to display off	tshut-off	2	-	-	frame
- 1 line: 408 clk - 1 frame: 262 line - DOTCLK = 6.5MHz		33.4	-	-	ms

Note: DOTCLK must be maintained at least 2 frames after the rising edge of SHUT.
 Display become off at the 2nd falling edge of VSTNC after the falling edge of SHUT.
 If RESET signal is necessary for power down, provide it after the 2-frames-cycle of the SHUT period.

Table 4: Power Down Sequence

• Write SPI



Note: The example writes "0x1264h" to register R28h.
SPID connected to VSS.

Figure 6: (a) SPI interface Timing Diagram & Write SPI Example

• Read SPI

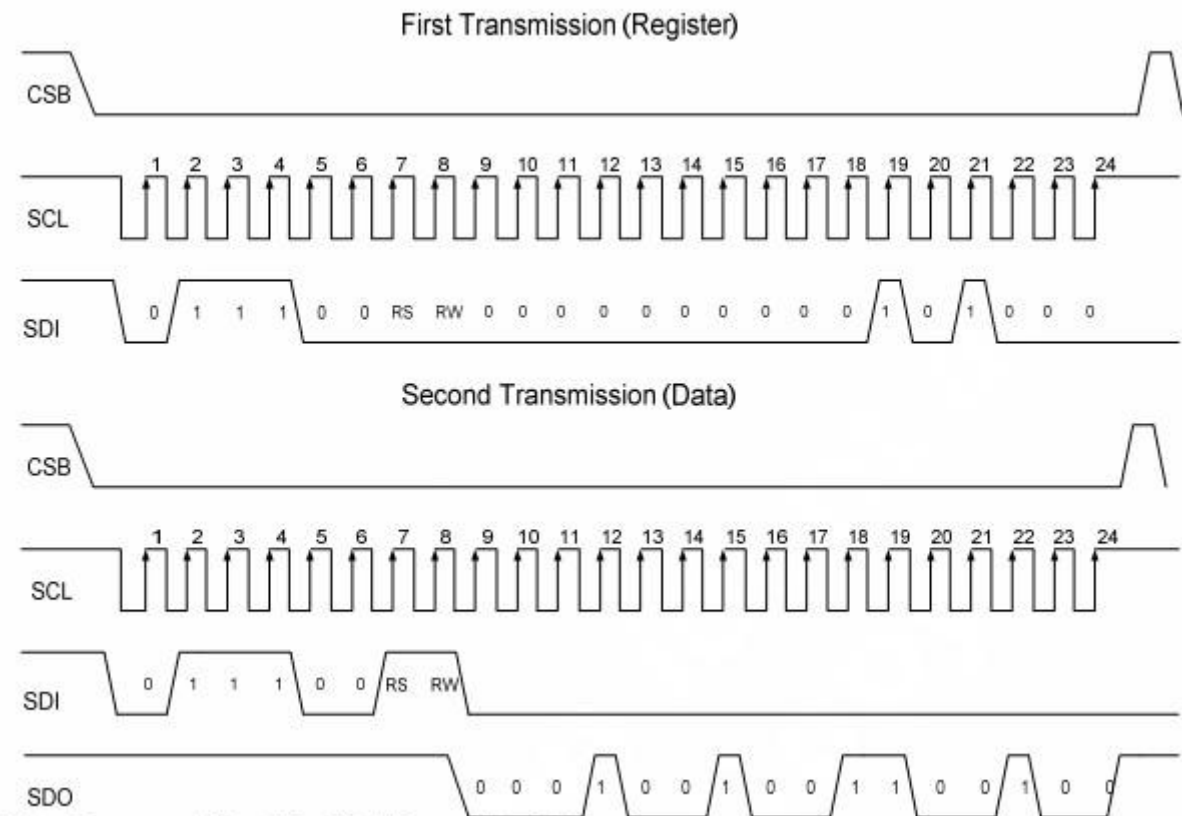


Figure 7: (b) SPI interface Timing Diagram & Read SPI Example

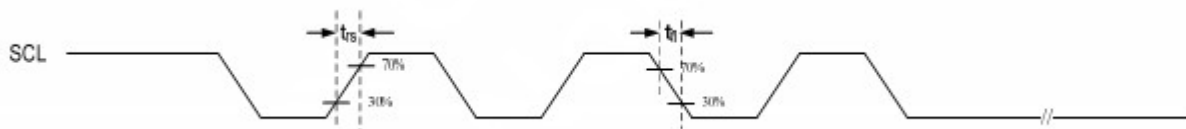


Figure 8: Rising/Falling Time

Characteristics	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
Serial Clock Frequency	fclk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	ns
Clock Low Width	tsl	25	-	-	ns
Clock High Width	tsh	25	-	-	ns
Clock Rising Time	trs	-	-	30	ns
Clock Falling Time	tfl	-	-	30	ns
Chip Select Hold Time	tcsh	10	-	-	ns
Chip Select High Delay Time	tcsd	20	-	-	ns
Data Setup Time	tds	5	-	-	ns
Data Hold Time	tdh	10	-	-	ns

Table 5: SPI Timing

11. Quality Assurance

11.1 Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2 Standard for Quality Test

11.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

11.2.2 Sampling Criteria:

Visual inspection: AQL 1.5%

Electrical functional: AQL 0.65%.

11.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3 Nonconforming Analysis & Disposition

11.3.1 Nonconforming analysis:

11.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.

11.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

11.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.

11.3.2 Disposition of nonconforming:

11.3.2.1 Non-conforming product over PPM level will be replaced.

11.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

11.4 Agreement Items

Shall negotiate with customer if the following situation occurs:

11.4.1 There is any discrepancy in standard of quality assurance.

11.4.2 Additional requirement to be added in product specification.

11.4.3 Any other special problem.

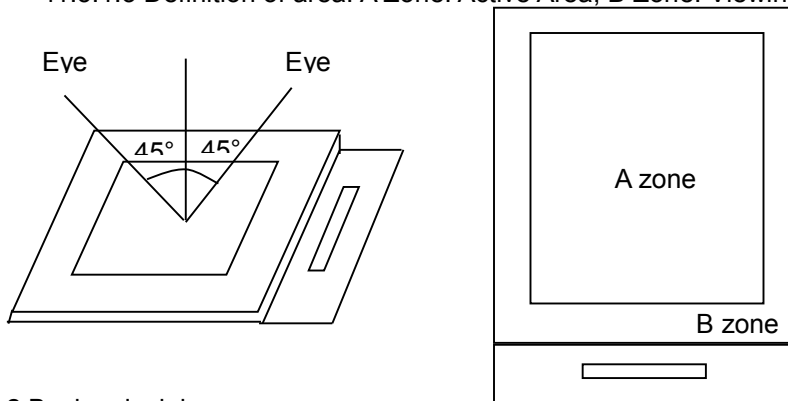
11.5 Standard of the Product Visual Inspection

11.5.1 Appearance inspection:

11.5.1.1 The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

11.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

11.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,

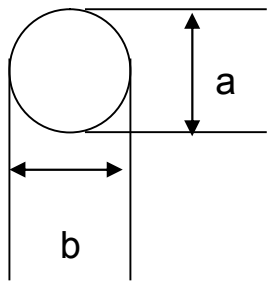
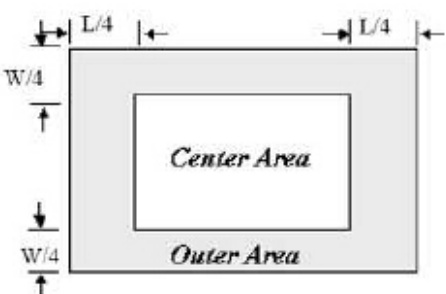


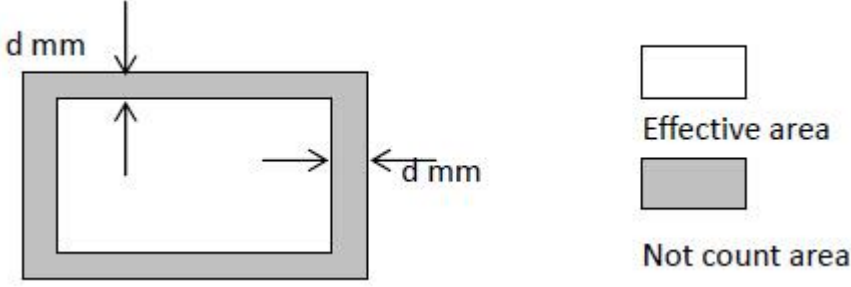
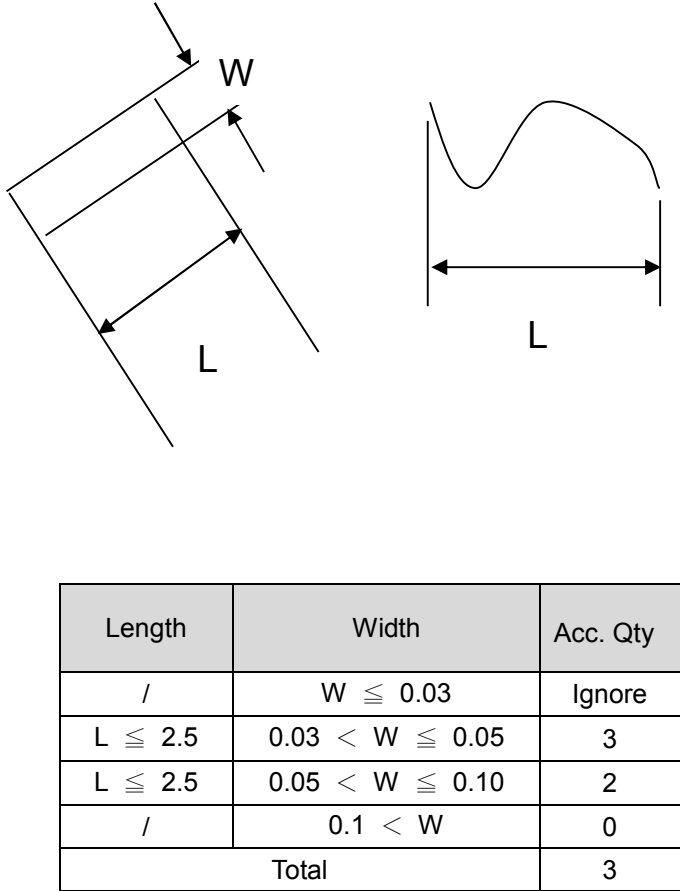
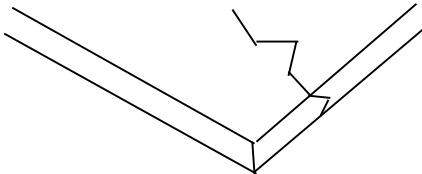
11.5.2 Basic principle:

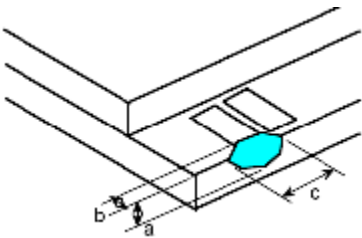
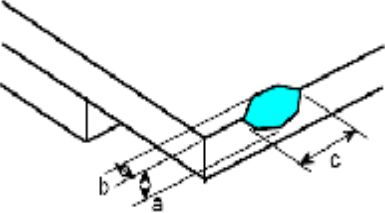
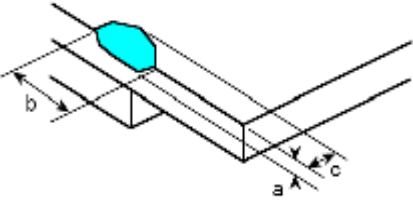
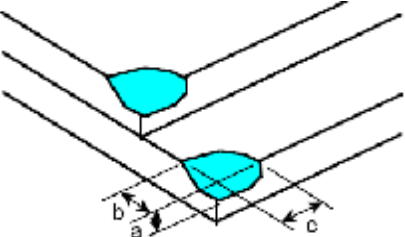
11.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

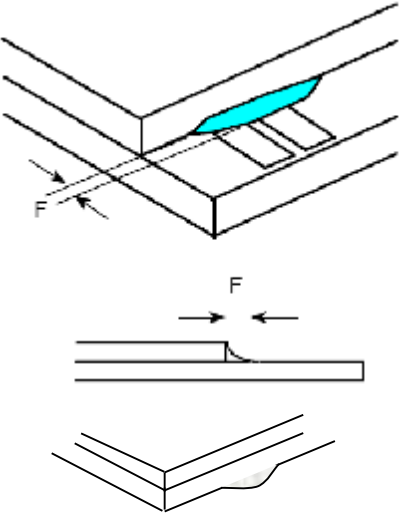
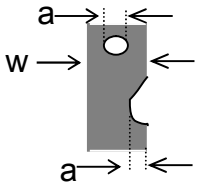
11.5.2.2 New item must be added on time when it is necessary.

11.6 Inspection Specification

No.	Item	Criteria (Unit: mm)																		
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	 <p>$\phi = (a + b) / 2$</p>																		
		<table border="1"> <thead> <tr> <th>Size</th> <th>Area</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\phi \leq 0.10$</td> <td></td> <td>Ignore</td> </tr> <tr> <td>$0.10 < \phi \leq 0.15$</td> <td></td> <td>2</td> </tr> <tr> <td>$0.15 < \phi \leq 0.25$</td> <td></td> <td>1</td> </tr> <tr> <td>$0.25 < \phi$</td> <td></td> <td>0</td> </tr> <tr> <td>Total</td> <td></td> <td>2 no include $\phi \leq 0.10$</td> </tr> </tbody> </table> <p>Distance between 2 defects should more than 3mm apart.</p>	Size	Area	Acc. Qty	$\phi \leq 0.10$		Ignore	$0.10 < \phi \leq 0.15$		2	$0.15 < \phi \leq 0.25$		1	$0.25 < \phi$		0	Total		2 no include $\phi \leq 0.10$
Size	Area	Acc. Qty																		
$\phi \leq 0.10$		Ignore																		
$0.10 < \phi \leq 0.15$		2																		
$0.15 < \phi \leq 0.25$		1																		
$0.25 < \phi$		0																		
Total		2 no include $\phi \leq 0.10$																		
02	Electrical Defect (Minor defect)	<table border="1"> <thead> <tr> <th></th> <th>Display Area</th> <th>Total</th> <th>Note1</th> </tr> </thead> <tbody> <tr> <td>Bright dot</td> <td>0</td> <td>0</td> <td rowspan="3"></td> </tr> <tr> <td>Dark dot</td> <td>$N \leq 2$</td> <td>$N \leq 2$</td> </tr> <tr> <td>Total dot</td> <td>$N \leq 2$</td> <td>$N \leq 2$</td> </tr> <tr> <td>Mura</td> <td colspan="2">Not visible through 5% ND filters.</td> <td>Note 2</td> </tr> </tbody> </table>		Display Area	Total	Note1	Bright dot	0	0		Dark dot	$N \leq 2$	$N \leq 2$	Total dot	$N \leq 2$	$N \leq 2$	Mura	Not visible through 5% ND filters.		Note 2
			Display Area	Total	Note1															
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Total dot	$N \leq 2$	$N \leq 2$																		
Mura	Not visible through 5% ND filters.		Note 2																	
<p>Remark:</p> <p>1. Bright dot caused by scratch and foreign object accords to item 1.</p>																				
03	Inactive Area (Minor defect)	<p>Line Criteria: $L \leq 1\text{mm}, W \leq 0.1\text{mm}$, Dot Criteria: Please refer to Note 1,2&3 Note1: Definition of Area</p> 																		
		<p>Note 2:</p> <table border="1"> <thead> <tr> <th>Size</th> <th>Inactive dot</th> <th>Center</th> <th>Outer</th> <th>Total</th> <th>Remark</th> </tr> </thead> <tbody> <tr> <td>All</td> <td>$\phi < 0.2\text{mm}$</td> <td colspan="4">Is not counted</td> </tr> <tr> <td><6"</td> <td>$0.2 \leq \phi \leq 0.3\text{mm}$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$</td> <td>$N \leq 1$</td> <td>$N \leq 2$</td> <td>$N \leq 3$</td> <td></td> </tr> </tbody> </table> <p>Note3: Inactive area $D < 0.2\text{mm}$ is not counted without appearance observation.</p> <p>Remark: Effective area is from the POL cutting side to 0.5mm of inside. This is no count area. Other part is effective area. In no count area, any defect can ignore. In effective area, have to judge from above-mentioned specification.</p>	Size	Inactive dot	Center	Outer	Total	Remark	All	$\phi < 0.2\text{mm}$	Is not counted				<6"	$0.2 \leq \phi \leq 0.3\text{mm}$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 1$	$N \leq 2$	$N \leq 3$	
Size	Inactive dot	Center	Outer	Total	Remark															
All	$\phi < 0.2\text{mm}$	Is not counted																		
<6"	$0.2 \leq \phi \leq 0.3\text{mm}$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 1$	$N \leq 2$	$N \leq 3$																

		
<p>04</p>	<p>Black and White line Scratch Foreign material (Line type) (Minor defect)</p>	 <p>Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.</p>
<p>05</p>	<p>Glass Crack (Minor defect)</p>	 <p>Crack is potential to enlarge, any type is not allowed.</p>

<p>06</p>	<p>Glass Chipping Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>3</td> </tr> <tr> <td colspan="2">a < Glass Thickness</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	3	a < Glass Thickness			
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	3											
a < Glass Thickness												
<p>07</p>	<p>Glass Chipping Rear of Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2">a < Glass Thickness</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	a < Glass Thickness	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
a < Glass Thickness												
<p>08</p>	<p>Glass Chipping Except Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2">a < Glass Thickness</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	a < Glass Thickness	
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$c > 3.0, b < 1.0$	1											
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a < Glass Thickness												
<p>09</p>	<p>Glass Corner Chipping: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c < 3.0, b < 3.0$</td> <td>Ignore</td> </tr> <tr> <td colspan="2">a < Glass Thickness</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c < 3.0, b < 3.0$	Ignore	a < Glass Thickness					
Length and Width	Acc. Qty											
$c < 3.0, b < 3.0$	Ignore											
a < Glass Thickness												

<p>10</p>	<p>Glass Burr: (Minor defect)</p> 	<table border="1" data-bbox="869 264 1337 353"> <thead> <tr> <th>Length</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>F < 1.0</td> <td>Ignore</td> </tr> </tbody> </table> <p>Glass burr don't affect assemble and module dimension.</p>	Length	Acc. Qty	F < 1.0	Ignore						
Length	Acc. Qty											
F < 1.0	Ignore											
<p>11</p>	<p>FPC Defect: (Minor defect)</p> 	<p>11.1 Dent, pinhole width $a < w/3$. (w: circuitry width.)</p> <p>11.2 Open circuit is unacceptable.</p> <p>11.3 No oxidation, contamination and distortion.</p>										
<p>12</p>	<p>Bubble on Polarizer (Minor defect)</p>	<table border="1" data-bbox="742 1299 1212 1512"> <thead> <tr> <th>Diameter</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.20$</td> <td>Ignore</td> </tr> <tr> <td>$0.20 < \varphi \leq 0.30$</td> <td>4</td> </tr> <tr> <td>$0.30 < \varphi \leq 0.50$</td> <td>1</td> </tr> <tr> <td>$0.50 < \varphi$</td> <td>None</td> </tr> </tbody> </table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
<p>13</p>	<p>Dent on Polarizer (Minor defect)</p>	<table border="1" data-bbox="742 1579 1212 1792"> <thead> <tr> <th>Diameter</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.20$</td> <td>Ignore</td> </tr> <tr> <td>$0.20 < \varphi \leq 0.30$</td> <td>4</td> </tr> <tr> <td>$0.30 < \varphi \leq 0.50$</td> <td>1</td> </tr> <tr> <td>$0.50 < \varphi$</td> <td>None</td> </tr> </tbody> </table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
<p>14</p>	<p>Bezel</p>	<p>14.1 No rust, distortion on the Bezel.</p> <p>14.2 No visible fingerprints, stains or other contamination.</p>										

<p>15</p>	<p>Touch Panel</p>	<p>D: Diameter W: width L: length 15.1 Spot: $D < 0.25$ is acceptable $0.25 \leq D \leq 0.4$ 2dots are acceptable and the distance between defects should more than 10 mm. $D > 0.4$ is unacceptable 15.2 Dent: $D > 0.40$ is unacceptable 15.3 Scratch: $W \leq 0.03$, $L \leq 10$ is acceptable, $0.03 < W \leq 0.10$, $L \leq 10$ is acceptable Distance between 2 defects should more than 10 mm. $W > 0.10$ is unacceptable.</p>
<p>16</p>	<p>LCD Ripple</p>	<p>Touch the touch panel, cannot see the LCD ripple. Pen: R 0.8mm silicon rubber. Operation Force:100g</p>
<p>16</p>	<p>PCB</p>	<p>16.1 No distortion or contamination on PCB terminals. 16.2 All components on PCB must same as documented on the BOM/component layout. 16.3 Follow IPC-A-600F.</p>
<p>17</p>	<p>Soldering</p>	<p>Follow IPC-A-610C standard</p>
<p>18</p>	<p>Electrical Defect (Major defect)</p>	<p>The below defects must be rejected. 18.1 Missing vertical / horizontal segment, 18.2 Abnormal Display. 18.3 No function or no display. 18.4 Current exceeds product specifications. 18.5 LCD viewing angle defect. 18.6 No Backlight. 18.7 Dark Backlight. 18.8 Touch Panel no function.</p>

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

11.7 Classification of Defects

11.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

11.7.2 Two minor defects are equal to one major in lot sampling inspection.

11.8 Identification/marketing criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

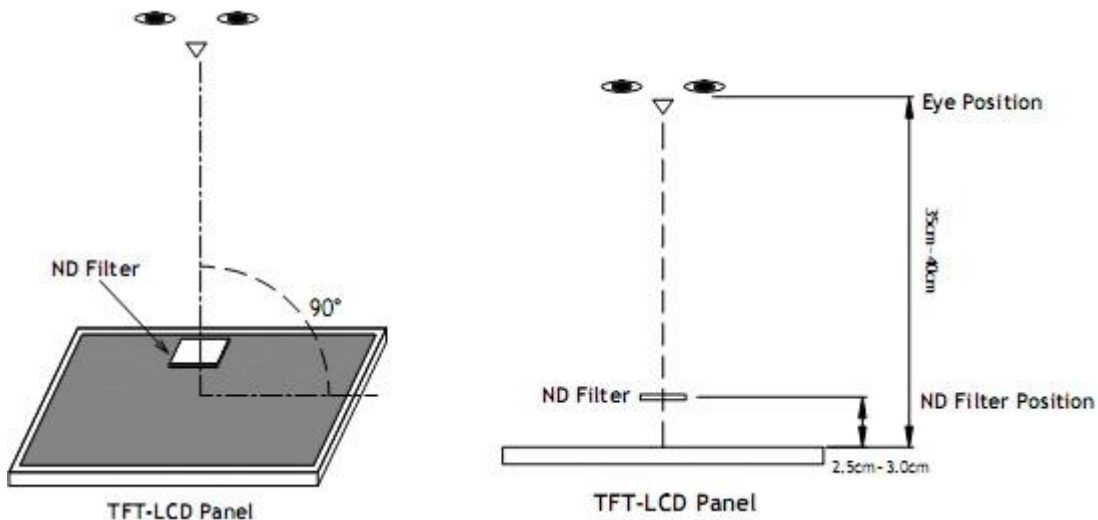
11.9Packaging

11.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.

11.9.2 Modules inside package box should have compliant mark.

11.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

12. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70°C, 96Hrs	2	GB/T2423.2-2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1-2008
3	High Humidity	50°C, 90%RH, 96Hrs	2	GB/T2423.3-2006
4	High Temperature Storage	80°C, 96Hrs	2	GB/T2423.2-2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1-2008
6	Thermal Cycling Test	-20°C, 60min~70°C, 60min, 20 cycles.	2	GB/T2423.22-2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14-2009
8	Electrical Static Discharge	Air: ±8KV 150pF/330Ω 5 times Contact: ±4KV 150pF/330Ω 5 times	2	GB/T17626.2-2006
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8-1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

13. Precautions and Warranty

13.1 Safety

13.1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

13.1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

13.2 Handling

13.2.1 Reverse and use within ratings in order to keep performance and prevent damage.

13.2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

13.3 Storage

13.3.1 Do not store the LCD module beyond the specified temperature ranges.

13.4 Metal Pin (Apply to Products with Metal Pins)

13.4.1 Pins of LCD and Backlight

13.4.1.1 Solder tip can touch and press on the tip of Pin LEAD during the soldering

13.4.1.2 Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

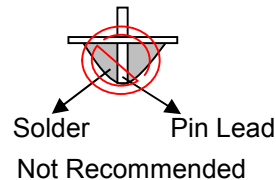
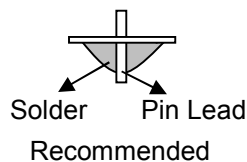
Maximum Solder Temperature: 370℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20℃

Typical Soldering Time: ≤3s

13.4.1.3 Solder Wetting



13.4.2 Pins of EL

13.4.1 Solder tip can touch and press on the tip of EL leads during soldering.

13.4.2 No Solder Paste on the soldering pad on the motherboard is recommended.

13.4.3 Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290℃

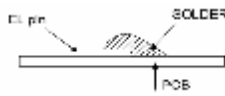
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

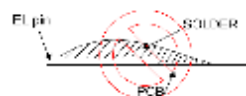
13.4.4 No horizontal press on the EL leads during soldering.

13.4.5 180° bend EL leads three times is not allowed.

13.4.2.6 Solder Wetting



Recommended

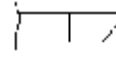


Not Recommended

13.4.2.7 The type of the solder iron:

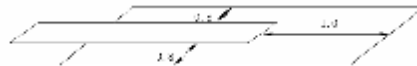


Recommended



Not Recommended

13.4.2.8 Solder Pad



13.5 Operation

- 13.5.1 Do not drive LCD with DC voltage
- 13.5.2 Response time will increase below lower temperature
- 13.5.3 Display may change color with different temperature
- 13.5.4 Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear “fractured”.

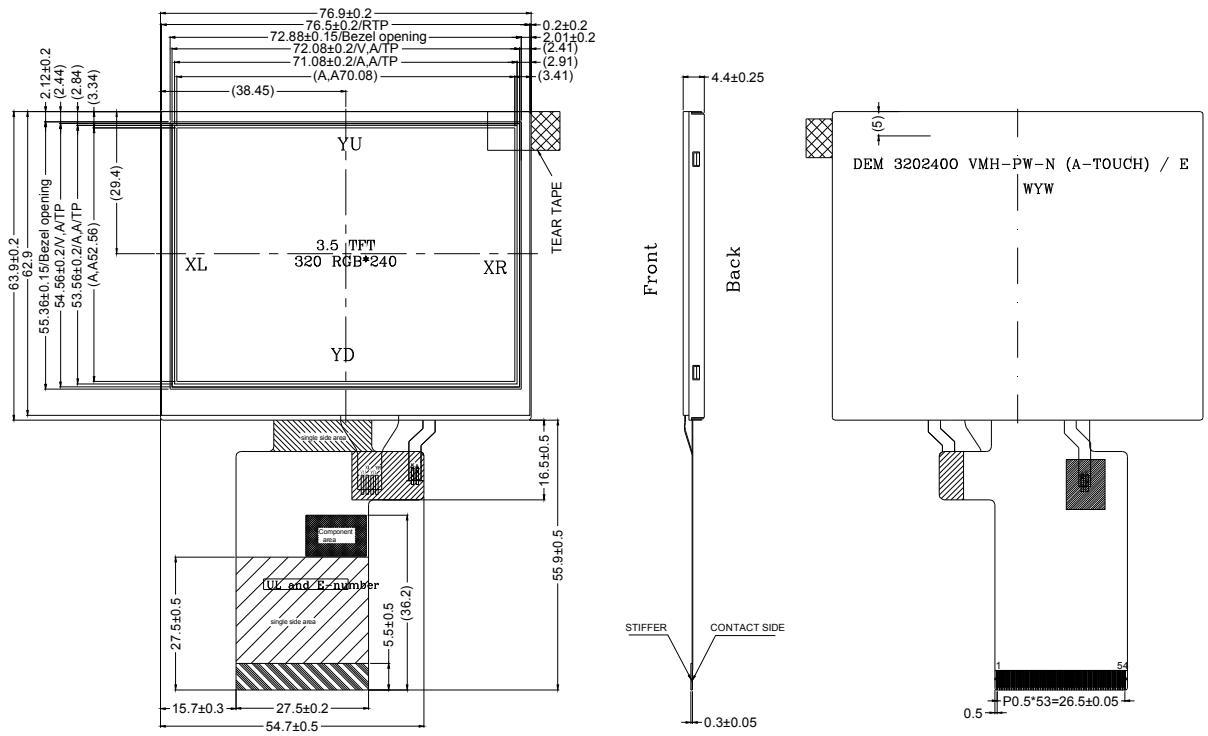
13.6 Static Electricity

- 13.6.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 13.6.2 The normal static prevention measures should be observed for work clothes and benches.
- 13.6.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

13.7 Limited Warranty

- 13.7.1 Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 13.7.2 If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 13.7.3 After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

14. Outline Drawing



- NOTES:
1. Display Size: 3.5" TFT
 2. Viewing Direction: Full View
 3. Display Mode: MVA, Transmissive / Normal White / Anti-Glare
 4. Operation Temperature: -20°C to +70°C
 5. Storage Temperature: -30°C to +80°C
 6. Driver IC: Himax, HX8238D
 7. Power Supply Voltage: 3.3 Volt (typ.)
 8. Backlight: White (10xLEDs) / 16 Volt / 40mA (typ.)
 9. Luminance: 330cd/m2 (typ.)
 10. Lifetime: 30000h (typ.)
 11. ROHS must be complied
- * Unspecification tolerance are ±0.2mm

PIN	SYMBOL
1	LED-K
2	LED-K
3	LED-A
4	LED-A
5	NC
6	NC
7	NC
8	RESET
9	/CS
10	SCK
11	SDI
12	B0
13	B1
14	B2
15	B3
16	B4
17	B5
18	B6
19	B7
20	G0
21	G1
22	G2
23	G3
24	G4
25	G5
26	G6
27	G7
28	B0
29	B1
30	B2
31	B3
32	B4
33	B5
34	B6
35	B7
36	H5VNC
37	V5VNC
38	DOTCLK
39	NC
40	NC
41	VDD
42	VDD
43	NC
44	NC
45	NC
46	NC
47	NC
48	XR
49	YD
50	XL
51	YU
52	BEN
53	GND
54	GND